



- NOTE:
- MATERIAL:  
HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, COLOR: BLACK.  
TERMINAL: COPPER ALLOY, THICKNESS 0.20MM.
  - FINISH:  
CONTACT AREA: 0.75 MICRON GOLD MIN OVER 1.25 MICRON NICKEL MIN.  
SOLDER AREA: GOLD FLASH OVER 1.25 MICRON NICKEL MIN.  
REST AREA: 1.25 MICRON NICKEL MIN.
  - COPLANARITY: 0.1 MAX AMONG THESE SOLDER TAILS.
  - PRODUCT SPECIFICATION: PS-105040-001

SECTION Z-Z

RELEASED EC NO: SH2008-0623 DRWN: YWANG91 CHKD: YLZHU APPR: HWANG 2008/06/06 2008/06/06 2008/06/10	QUALITY SYMBOLS ▽=0 ◻=0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm    INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.15 ± --- 1 PLACE ± 0.2 ± --- ANGULAR ± 2 °	DIMENSION STYLE MM ONLY DRAWN BY: YWANG    DATE: 2008/03/12 CHECKED BY: YLZHU    DATE: 2008/03/12 APPROVED BY: HWANG    DATE: 2008/03/12	SCALE 8:1 DESIGN UNITS METRIC THIRD ANGLE PROJECTION	TITLE 2.0MM PITCH 3 CIRCUITS BATTERY CONNECTOR
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. 1050400001	MOLEX INCORPORATED DOCUMENT NO. SD-105040-001	SHEET NO. 1 OF 1	
	SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
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